PRODUCT / PROCESS CHANGE NOTIFICATION

| 1. PCN basic data | | |
|----------------------|--|---|
| 1.1 Company | | STMicroelectronics International N.V |
| 1.2 PCN No. | | AMS/22/13142 |
| 1.3 Title of PCN | | BOM Changes (LF plating and DA) on selected VIPER products (TFME subcon as assy plant). |
| 1.4 Product Category | | Pks Refer to the enclosed products list. |
| 1.5 Issue date | | 2022-01-05 |

| 2. PCN Team | | |
|---------------------------|--------------------------|--|
| 2.1 Contact supplier | | |
| 2.1.1 Name | ROBERTSON HEATHER | |
| 2.1.2 Phone | +1 8475853058 | |
| 2.1.3 Email | heather.robertson@st.com | |
| 2.2 Change responsibility | | |
| 2.2.1 Product Manager | Domenico ARRIGO | |
| 2.1.2 Marketing Manager | Vittorio GIAMMELLO | |
| 2.1.3 Quality Manager | Alessandro PLATINI | |

| 3. Change | | | |
|--------------|--|----------------------------|--|
| 3.1 Category | 3.2 Type of change | 3.3 Manufacturing Location | |
| Materials | Direct material: usage of material without any modification having same part number, and produced in a new plant of a qualified supplier | Assy TFME (subco) | |

| 4. Description of change | | | |
|---|---|--|--|
| Old New | | | |
| 4.1 Description | Leadframe: Ag plated Die Attach: Ablestik 8390S. | Leadframe: Ag Plated with Cu Ring Die Attach: Ablebond 8200T. | |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | No Impact | | |

| 5. Reason / motivation for change | | |
|-----------------------------------|---|--|
| 5.1 Motivation | Standardization of materials within the product family. | |
| 5.2 Customer Benefit | MANUFACTURING FLEXIBILITY | |

| 6. Marking of parts / traceability of change | | |
|--|---------|--|
| 6.1 Description | New FGs | |

| 7. Timing / schedule | | |
|-------------------------------------|--------------|--|
| 7.1 Date of qualification results | 2021-09-21 | |
| 7.2 Intended start of delivery | 2022-06-10 | |
| 7.3 Qualification sample available? | Upon Request | |

| 8. Qualification / Validation | | | |
|---|--------------------------|---------------|------------|
| 8.1 Description | 13142 RR004921CO6410.pdf | | |
| 8.2 Qualification report and qualification results | | Issue Date | 2022-01-05 |

9. Attachments (additional documentations)

13142 Public product.pdf 13142 RR004921CO6410.pdf

| 10. Affected parts | | |
|-------------------------|-------------------------|--------------------------|
| 10. 1 Current | | 10.2 New (if applicable) |
| 10.1.1 Customer Part No | 10.1.2 Supplier Part No | 10.1.2 Supplier Part No |
| | VIPER37HE | |
| | VIPER37LE | |
| | VIPER38HE | |
| | VIPER38LE | |



Public Products List

Publict Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCN Title : BOM Changes (LF plating and DA) on selected VIPER products (TFME subcon as assy plant). *PCN Reference :* AMS/22/13142

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

| VIPER37LE | VIPER38LE | VIPER38HE |
|-----------|-----------|-----------|
| VIPER37HE | | |

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